

GSIB10A05 THRU GSIB10A100**SINGLE PHASE GLASS
PASSIVATED BRIDGE RECTIFIER**

Voltage: 50 to 1000V

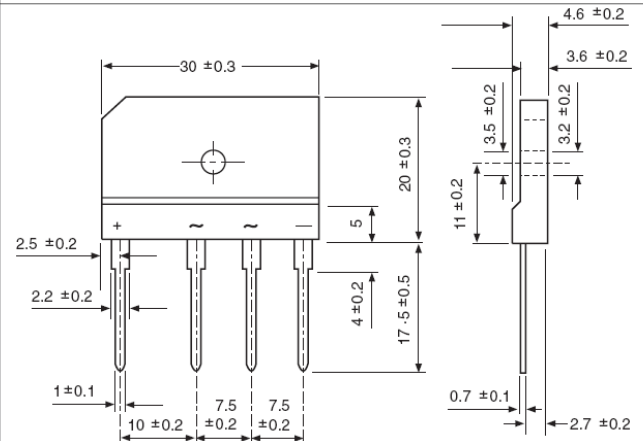
Current: 10.0A

**Features**

Glass passivated chip junction
Ideal for printed circuit board
High surge current capability
High case dielectric strength
This series is UL listed under Recognized Component Index,
file number E185029

Mechanical Data

Terminal: Plated leads solderable per MIL-STD 202E,
Method 208C
Case: UL-94 Class V-0 recognized Flame Retardant Epoxy
Polarity: Polarity symbol marked on body
Mounting position: any

GSIB-5S

Dimensions in millimeters

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

(single-phase, half -wave, 60HZ, resistive or inductive load rating at 25°C, unless otherwise stated,
for capacitive load, derate current by 20%)

	Symbol	GSIB1 0A05	GSIB1 0A10	GSIB1 0A20	GSIB1 0A40	GSIB1 0A60	GSIB1 0A80	GSIB1 0A100	units
Maximum repetitive peak reverse voltage	V _{rrm}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{rms}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{dc}	50	100	200	400	600	800	1000	V
Maximum average forward rectified output current at T _c = 100°C(Note1)	I _{f(av)}	10.0							A
Peak forward surge current single sine-wave superimposed on rated load (JEDEC Method)	I _{fsm}	180							A
Maximum instantaneous forward voltage drop per leg at 5.0A	V _f	1.0							V
Rating for fusing (t < 8.3ms)	I ² t	130							A ² Sec
Maximum DC reverse current at rated DC blocking voltage per leg	I _r	10.0 250							μA
Maximum thermal resistance per leg (Note1)	R _{th(jc)}	1.4							°C/W
Operating junction and storage temperature range	T _j , T _{stg}	-55 to +150							°C

Note:

1. Unit case mounted on Al plate heatsink
2. Recommended mounting position is to bolt down on heatsink with silicone thermal compound for maximum heat transfer with #6 screw

RATINGS AND CHARACTERISTIC CURVES GSIB10A05 THRU GSIB10A100

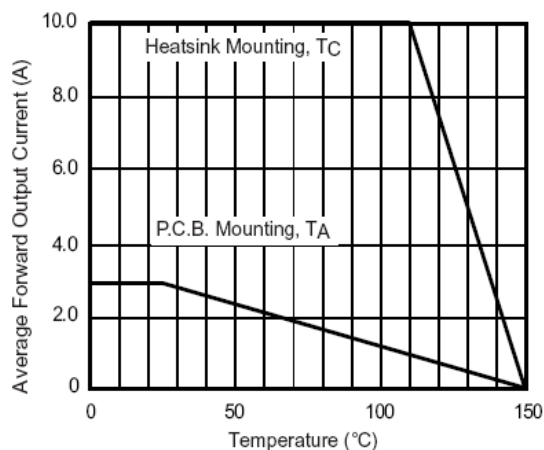


Figure 1. Derating Curve Output Rectified Current

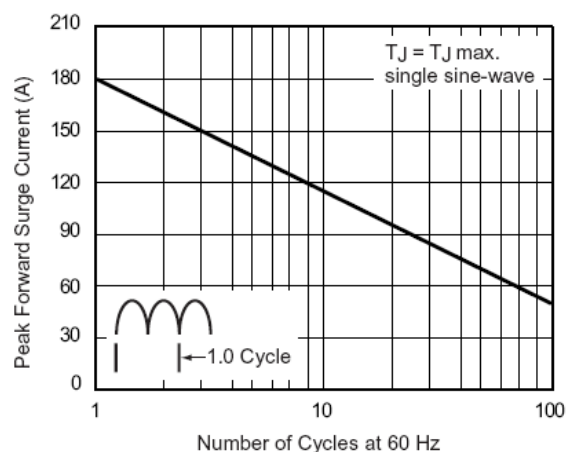


Figure 2. Maximum Non-Repetitive Peak Forward Surge Current Per Leg

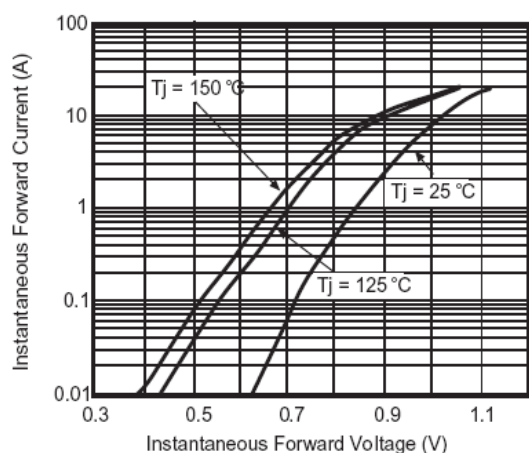


Figure 3. Typical Forward Characteristics Per Leg

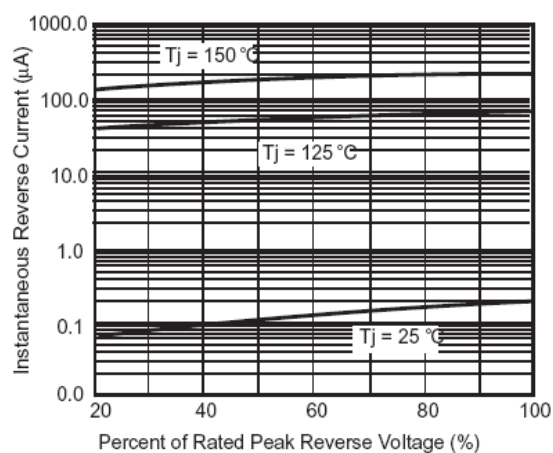


Figure 4. Typical Reverse Characteristics Per Leg

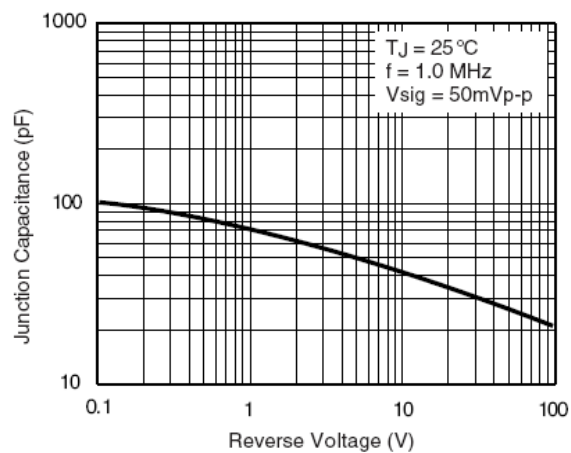


Figure 5. Typical Junction Capacitance Per Leg

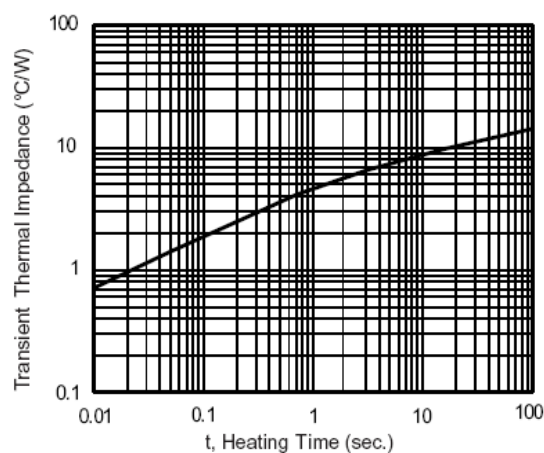


Figure 6. Typical Transient Thermal Impedance